

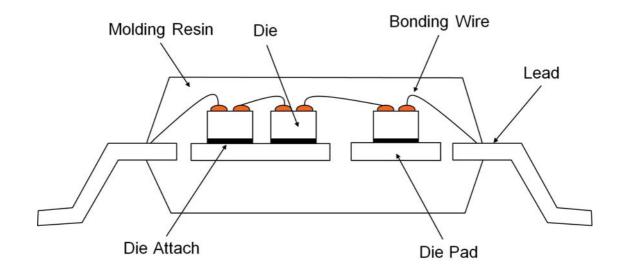
## Package Information: SSOP-B28W

## 1. Package Information

Package Name SSOP-B28W

Type SOP
Pin Count 28
Package Weight [g] 0.38
Lead Finish Pure Tin
MSL Level2a

## 2. Package Structure



## 3. Packing Specification

## 3.1 Packing form, Quantity, PIN1 Orientation

Packing Form Tape&Reel
Packing Quantity [pcs] 1,500
PIN 1 Orientation E2

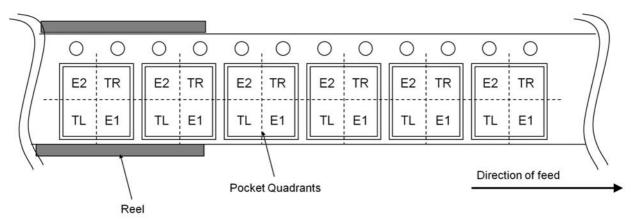


Fig.1 Quadrant Assignments for PIN 1 Orientation in Tape

E2 : PIN1 is placed to the top left corner. TR : PIN1 is placed to the top right corner.

TL: PIN1 is placed to the lower left. E1: PIN1 is placed to the lower right.

### 3.2 Use material

Item	Material
Embossed carrier tape	PS
Cover tape	PET+PE
Reel	PS
Desiccant	Clay
Envelope	Aluminum-laminated
Air cap	PE
Unit box	Cardboard
Shipping box	Cardboard

#### 3.3 Leader specification

No component pockets are 640 mm or more.

#### 3.4 Trailer specification

No component pockets are 160 mm or more. Tape is free from reel.

## 3.5 Peelback strength

Cover tape peelback strength is 0.2 N to 0.7 N.

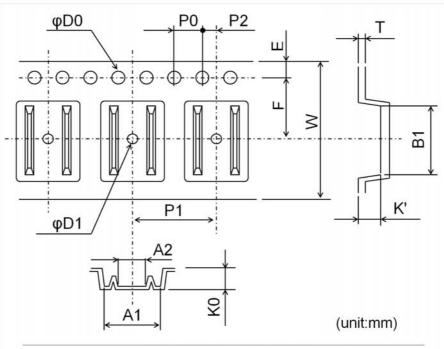
Peelback speed 300±10mm/min 165 to 180°

Fig. 2 Test method

### 3.6 Missing Ics

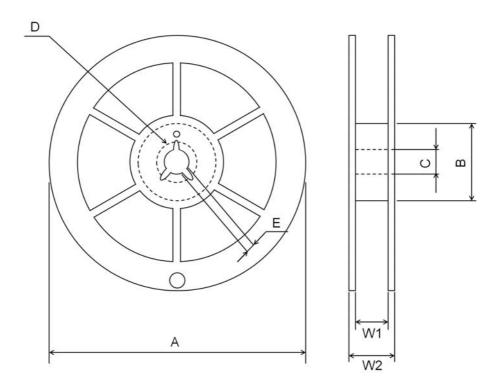
- (1) No consecutive dropouts.
- (2) A maximun 0.1 % of specified number of products in each packing may be missing.

# 3.7 Tape and Reel Specification 3.7.1 Tape Dimension



	Tape Dimension	Tape Tolerance
A1	10.9	±0.1
A2	7.75	±0.1
B1	9.50	±0.1
D0	φ1.5	MIN
D1	φ1.5	±0.1
E	1.75	±0.1
F	7.50	±0.1
K'	2.35	±0.1
K0	2.75	±0.1
P0	4.00	±0.1
P1	16.0	±0.1
P2	2.00	±0.1
Т	0.30	±0.05
W	16.0	±0.3

## 3.7.2 Reel Dimension

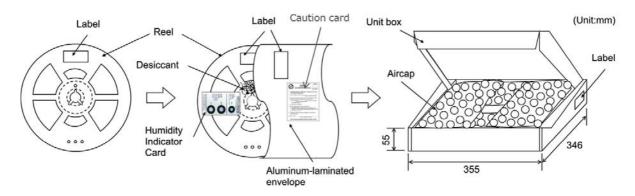


(unit:mm)

	Reel Dimension	Reel Tolerance
Α	330	±2.0
В	80	±1.0
С	13	±0.2
D	21	±0.8
Ε	2	±0.5
W1	17.4	±1.0
W2	21.4	±1.0

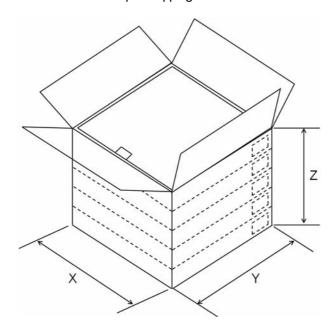
## 3.8 Packing Method

1 reel(s) or less per unit box



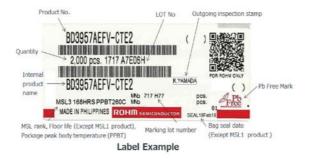
## 3.9 Packing Style

5 unit boxes or less per shipping box



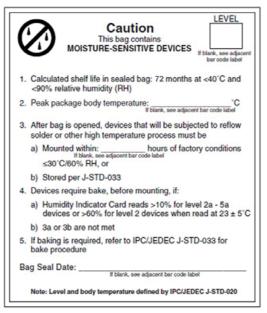
	(unit:mm)
Shipp	oing Box Dimension
X	372
Υ	368
Z	305

## 3.10 Label Specification



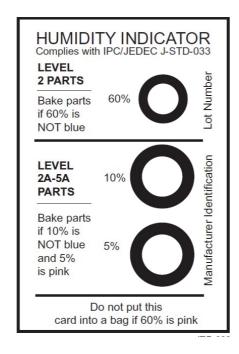
SSOP-B28W Package Information

## 3.11 Caution card specification

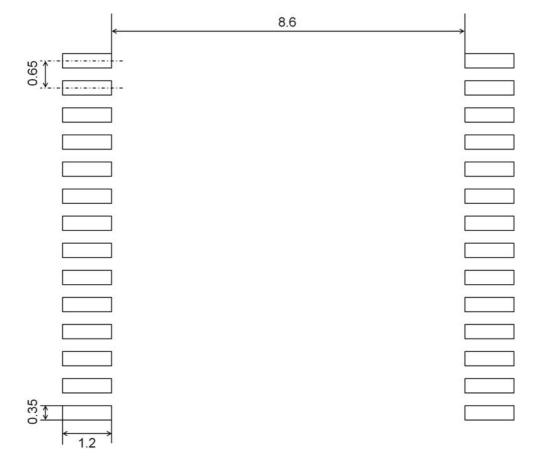


Remark ) Standard item 1. calculated shelf life in caution card is not applied for MSL1 product.

### 3.12 Indicator card specification



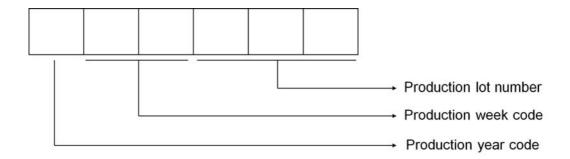
## 4. Footprint dimensions



(unit:mm)

In actual design, please optimize in accordance with the situation of your board design and soldering condition.

## 5. Marking Specification



## 6. Storage conditions

#### 6.1 Storage environment

Recommended storage conditions

	Min.	Max.	Unit
Temperature	5	30	°C
Humidity	-	70	% RH

#### 6.2 Storage period (Start to count since delivery date)

	Min.	Max.	Unit
Storage period	-	1	year

### 6.3 Specified storage period until soldering

	Min.	Max.	Unit
Acceptable time	-	672	hour

The above value is a time from opening the moisture-proof

packaging until the soldering. Cases where it is necessary to perform the drying process is the following.

Case 1: in excess of the above-mentioned "Acceptable time"

Case 2: it has passed more than 6 years not open

## Recommended the dry process conditions

	Temperature [°C]	Time [hour]
Reel <sup>(Note1)</sup>	60	72
Other Heat-proof container	125	24

(Note1) When carrying out the dry process in a "Reel" state, the peelback strength will change. Please refer to the following values:

	Min.	Max.	Unit
Peelback strength	0.2	0.9	N

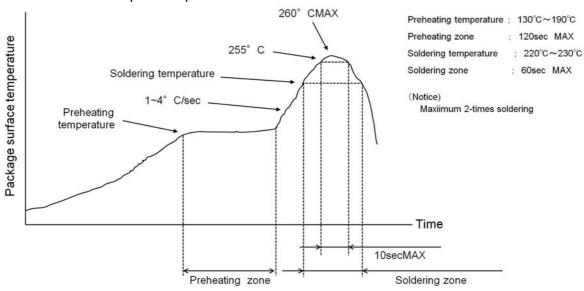
The drying process is the impact on the solderability because the oxidation of the terminal portion will occur. Therefore, specify the maximum times of the dry processing as follows:

Recommended execution count of the dry process

Mi	n. Max	. Unit
Reel	1	times
Other Heat-proof container	2	times

## 7. Soldering conditions

## 7.1 Recommended temperature profile for reflow



#### 7.2 Recommended condition for wave soldering

Preheating temperature : 120 °C to 150 °C

Preheating time : 60 sec MAX

Soldering temperature : 260  $^{\circ}$ C  $\pm$  3  $^{\circ}$ C

Soldering time : 12 sec MAX

#### Notes for wave soldering

- (1) Soldering time is provided for total soldering time in case of dual wave soldering.
- (2) Do not use other soldering methods with wave soldering.
- (3) Recommend to clean the board to eliminate flux, solder waste, and other impurities for reliability, after soldering.
- (4) Optimize soldering condition to prevent solder bridging.

#### 7.3 Recommended condition for solder iron

Solder iron temperature : 380 °C or less Mounting time : 4 sec or less

## Notes for solder iron

(1)Solder mounting time is the sec per 1 lead

#### Notes

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